

Supporting Information

Preparation of solid silver nanoparticles for inkjet printed flexible electronics with high conductivity

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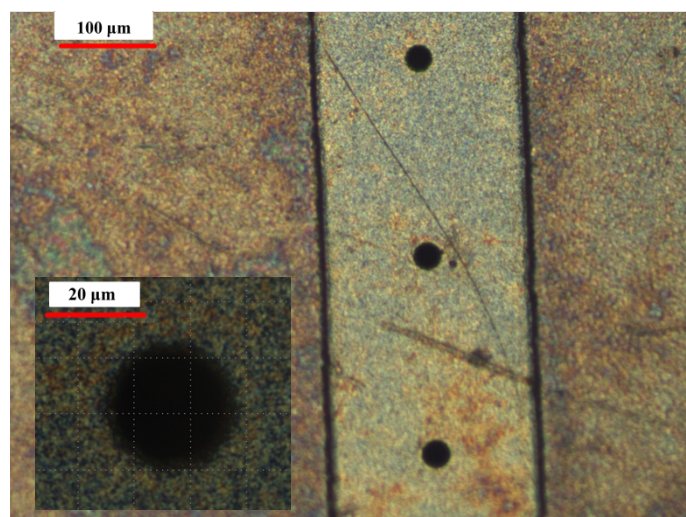


Figure S1. Optical microscope image of print-head orifice.

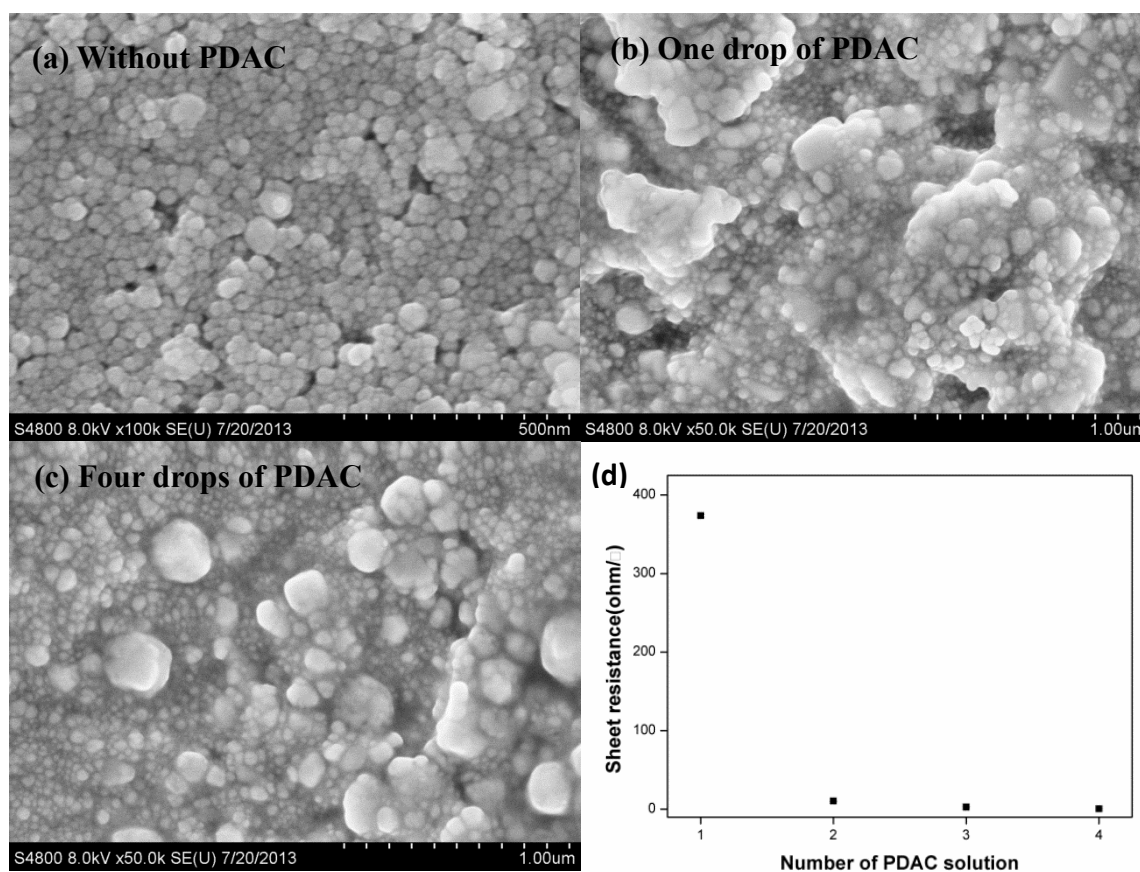


Figure S2. (a)~(c) SEM images and (d) sheet resistance of printed silver patterns treated with different amounts of PDAC solution at room temperature.

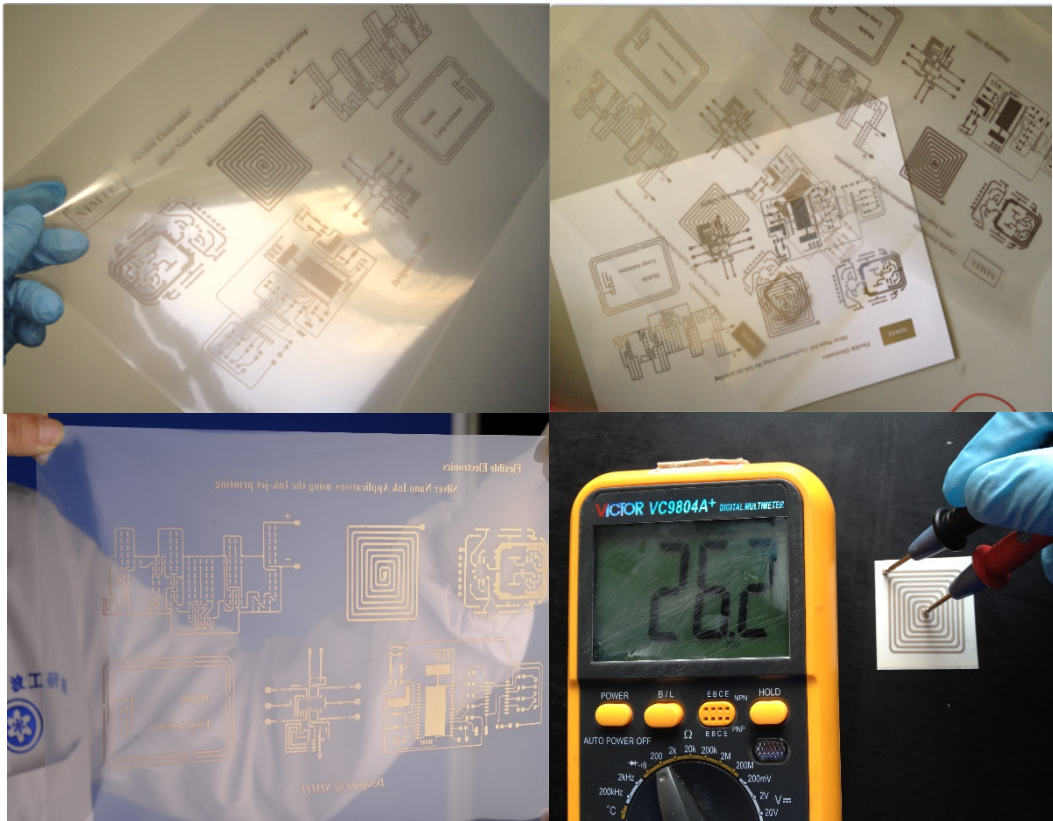


Figure S3. Different silver conductive 2D-patterns printed on various flexible substrates.

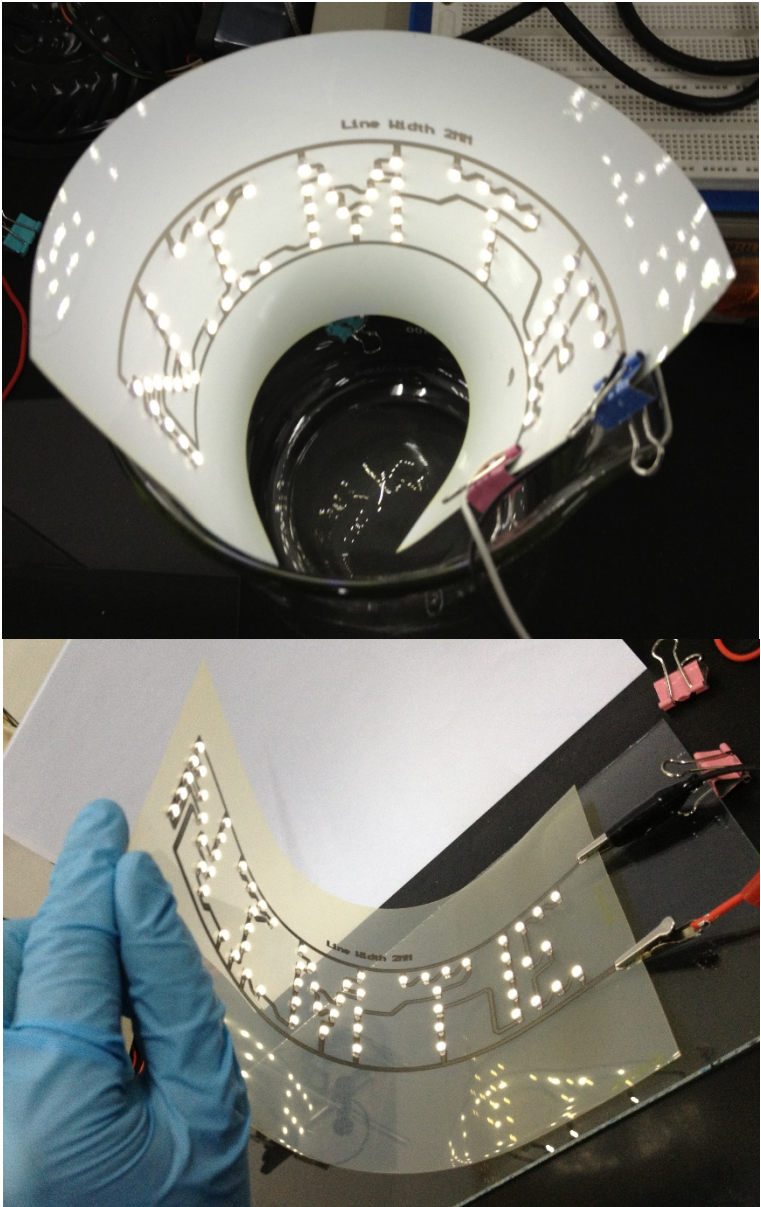


Figure S4. Demonstration of working LED device in a bend position.